



11NM70

Power MOSFET

11A, 700V N-CHANNEL SUPER-JUNCTION MOSFET

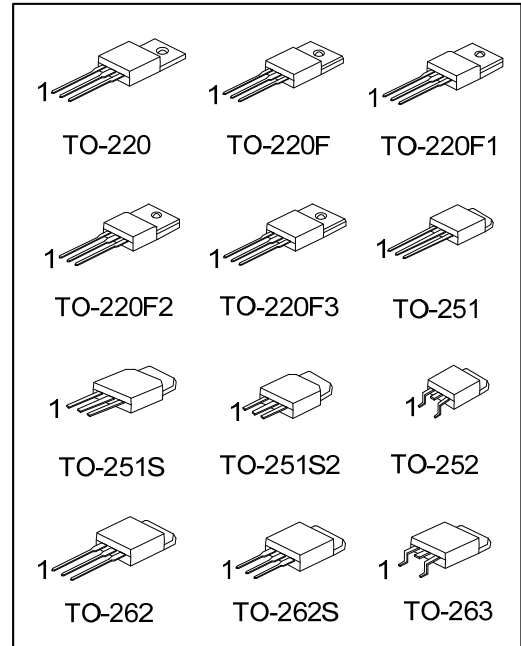
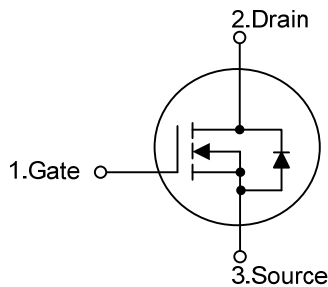
DESCRIPTION

The **UTC 11NM70** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

FEATURES

- * $R_{DS(ON)} \leq 0.58 \Omega$ @ $V_{GS}=10V$, $I_D=5.5A$
- * By using Super Junction Structure
- * Fast Switching
- * With 100% Avalanche Tested

SYMBOL



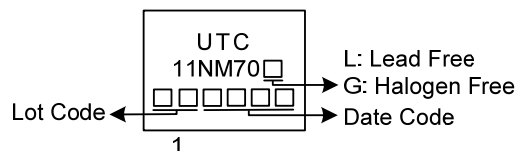
ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
11NM70L-TA3-T	11NM70G-TA3-T	TO-220	G	D	S	Tube
11NM70L-TF1-T	11NM70G-TF1-T	TO-220F1	G	D	S	Tube
11NM70L-TF2-T	11NM70G-TF2-T	TO-220F2	G	D	S	Tube
11NM70L-TF3-T	11NM70G-TF3-T	TO-220F	G	D	S	Tube
11NM70L-TF3T-T	11NM70G-TF3T-T	TO-220F3	G	D	S	Tube
11NM70L-TM3-T	11NM70G-TM3-T	TO-251	G	D	S	Tube
11NM70L-TMS-T	11NM70G-TMS-T	TO-251S	G	D	S	Tube
11NM70L-TMS2-T	11NM70G-TMS2-T	TO-251S2	G	D	S	Tube
11NM70L-TN3-R	11NM70G-TN3-R	TO-252	G	D	S	Tape Reel
11NM70L-T2Q-T	11NM70G-T2Q-T	TO-262	G	D	S	Tube
11NM70L-T2S-T	11NM70G-T2S-T	TO-262S	G	D	S	Tube
11NM70L-TQ2-T	11NM70G-TQ2-T	TO-263	G	D	S	Tube
11NM70L-TQ2-R	11NM70G-TQ2-R	TO-263	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

11NM70G-TA3-T (1) Packing Type (2) Package Type (3) Green Package	(1) T: Tube, R: Tape Reel (2) TA3: TO-220, TF1: TO-220F1, TF2: TO-220F2, TF3: TO-220F, TF3T: TO-220F3, TM3: TO-251, TMS: TO-251S, TMS2: TO-251S2, TN3: TO-252, T2Q: TO-262, T2S: TO-262S, TQ2: TO-263 (3) G: Halogen Free and Lead Free, L: Lead Free
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MARKING



■ ABSOLUTE MAXIMUM RATINGS ($T_C = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain to Source Voltage		V_{DSS}	700	V
Gate to Source Voltage		V_{GSS}	± 30	V
Continuous Drain Current	Continuous	I_D	11	A
Pulsed Drain Current	Pulsed (Note 2)	I_{DM}	22	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	166	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	3.5	V/ns
Power Dissipation	TO-220/TO-262 TO-262S/TO-263	P_D	85	W
	TO-220F/TO-220F1 TO-220F2/TO-220F3		30	W
	TO-251/TO-251S TO-251S2/TO-252		70	W
Junction Temperature		T_J	+150	$^\circ\text{C}$
Storage Temperature		T_{STG}	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature.

3. $L=65\text{mH}$, $I_{AS}=2.2\text{A}$, $V_{DD}=50\text{V}$, $R_G=25\Omega$, Starting $T_J=25^\circ\text{C}$.

4. $I_{SD} \leq 11\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, Starting $T_J=25^\circ\text{C}$.

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220/TO-220F TO-220F1/TO-220F2 TO-220F3/TO-262 TO-262S/TO-263	θ_{JA}	62.5	$^\circ\text{C}/\text{W}$
	TO-251/TO-251S TO-251S2/TO-252		110	$^\circ\text{C}/\text{W}$
Junction to Case	TO-220/TO-262 TO-262S/TO-263	θ_{JC}	1.47	$^\circ\text{C}/\text{W}$
	TO-220F/TO-220F1 TO-220F2/TO-220F3		4.16	$^\circ\text{C}/\text{W}$
	TO-251/TO-251S TO-251S2/TO-252		1.78 (Note)	$^\circ\text{C}/\text{W}$

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

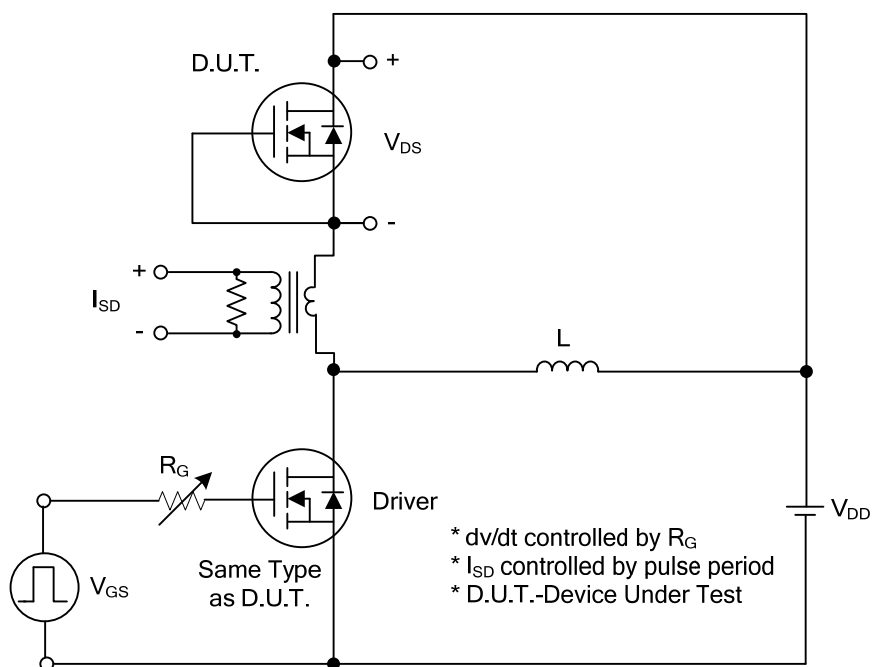
■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	700			V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =700V, V _{GS} =0V			10	μA
Gate-Source Leakage Current	I _{GSS}	V _{DS} =0V ,V _{GS} =±30V			±100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} = V _{GS} , I _D =250μA	2.5		4.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =5.5A			0.58	Ω
DYNAMIC PARAMETERS						
Input Capacitance	C _{ISS}	V _{DS} =25V,V _{GS} =0V, f=1.0MHz		750		pF
Output Capacitance	C _{OSS}			450		pF
Reverse Transfer Capacitance	C _{RSS}			40		pF
SWITCHING PARAMETERS						
Total Gate Charge (Note 1)	Q _G	V _{DS} =560V, V _{GS} =10V, I _D =11A , I _G =1mA (Note 1, 2)		36	50	nC
Gate to Source Charge	Q _{GS}			10		nC
Gate to Drain Charge	Q _{GD}			15		nC
Turn-ON Delay Time (Note 1)	t _{D(ON)}	V _{DD} =100V, V _{GS} =10V, I _D =11A, R _G =25Ω (Note 1, 2)		14		ns
Rise Time	t _R			24		ns
Turn-OFF Delay Time	t _{D(OFF)}			80		ns
Fall-Time	t _F			39		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Maximum Body-Diode Continuous Current	I _S				11	A
Maximum Body-Diode Pulsed Current	I _{SM}				22	A
Drain-Source Diode Forward Voltage (Note 1)	V _{SD}	I _S =11A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Time (Note 1)	t _{rr}	I _S =11A, V _{GS} =0V		370		ns
Body Diode Reverse Recovery Charge	Q _{rr}	dI _F /dt=100A/μs		11.08		μC

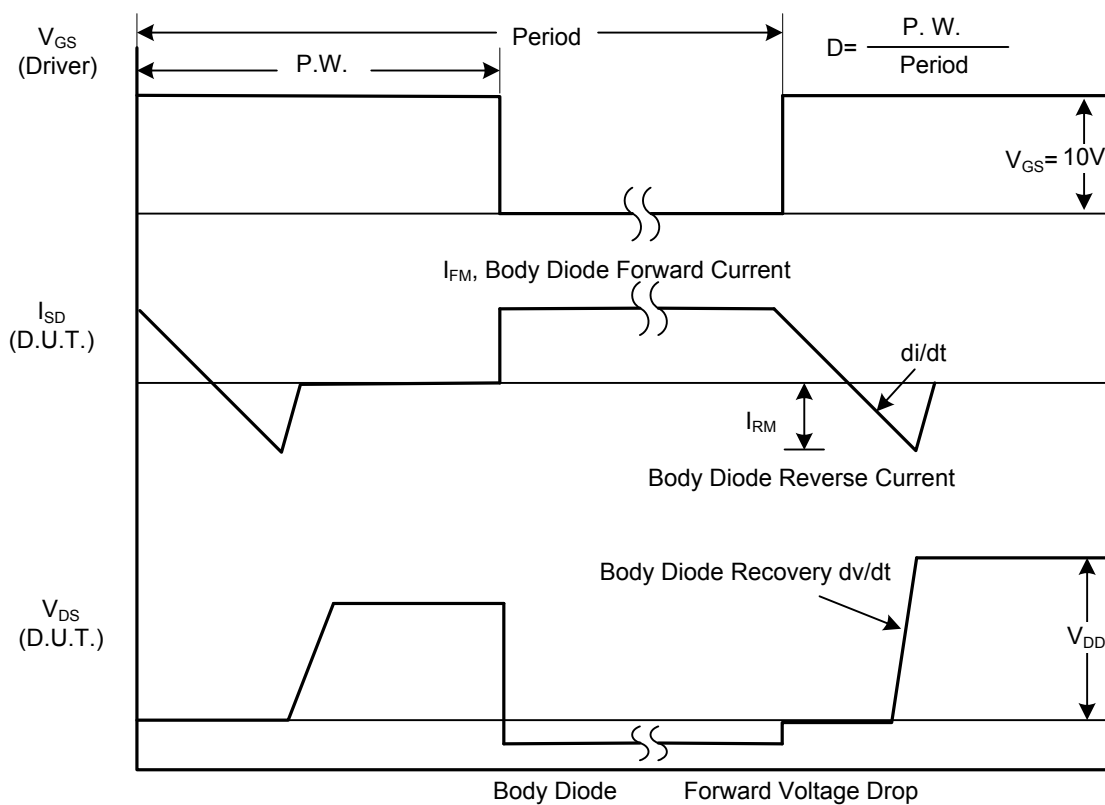
Notes: 1. Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2%.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

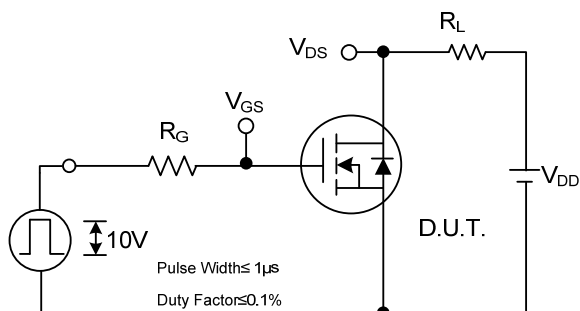


Peak Diode Recovery dv/dt Test Circuit

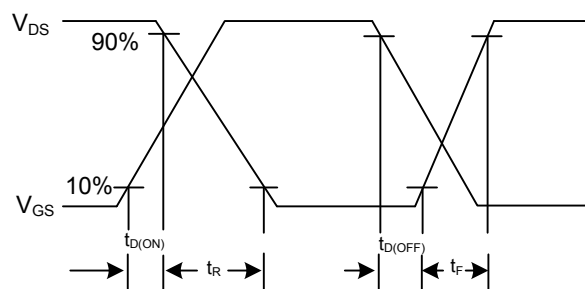


Peak Diode Recovery dv/dt Waveforms

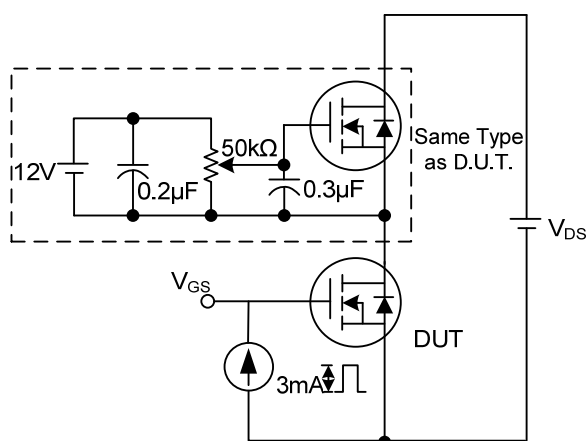
■ TEST CIRCUITS AND WAVEFORMS



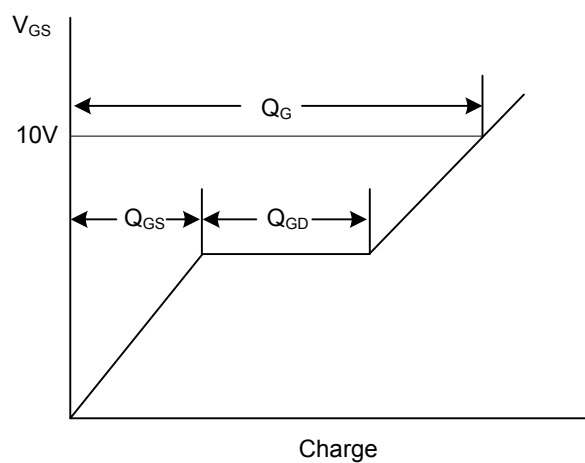
Switching Test Circuit



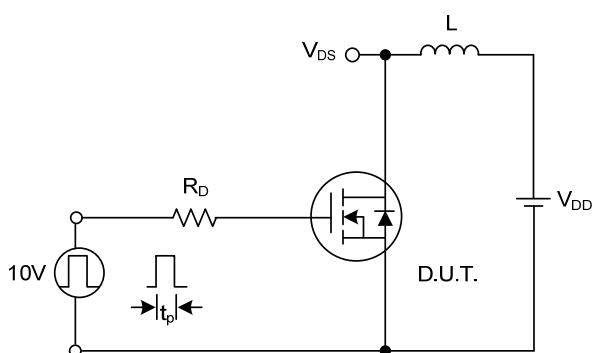
Switching Waveforms



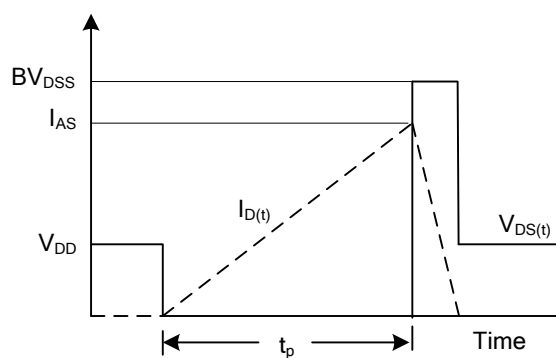
Gate Charge Test Circuit



Gate Charge Waveform

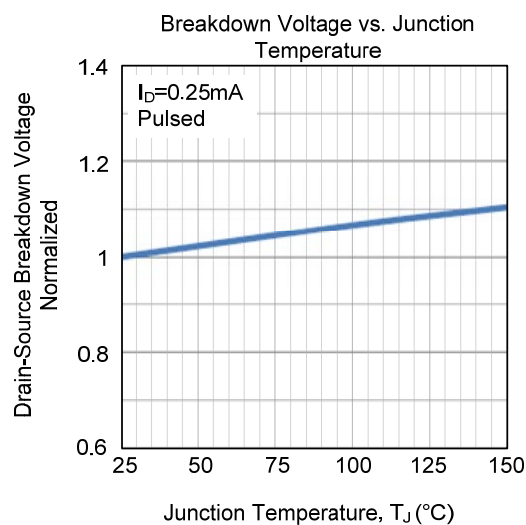
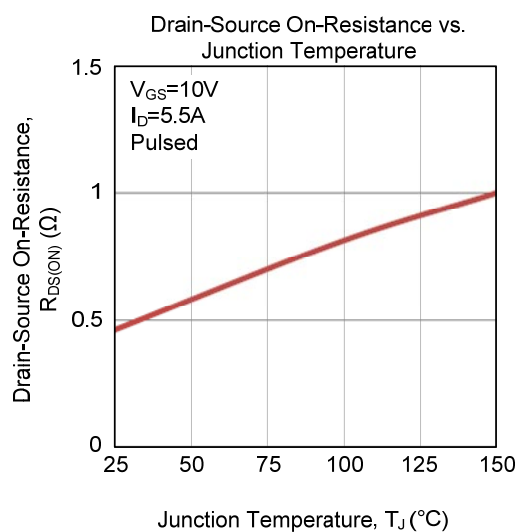
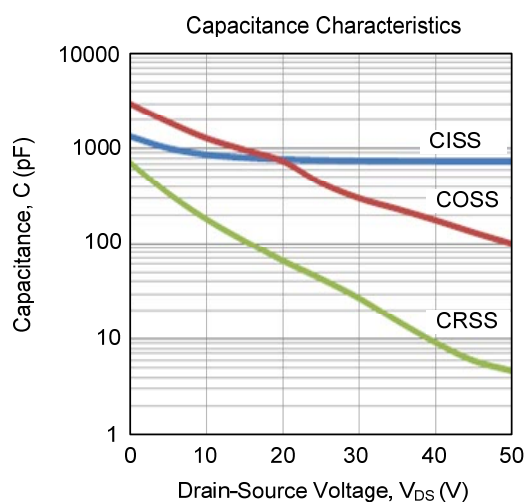
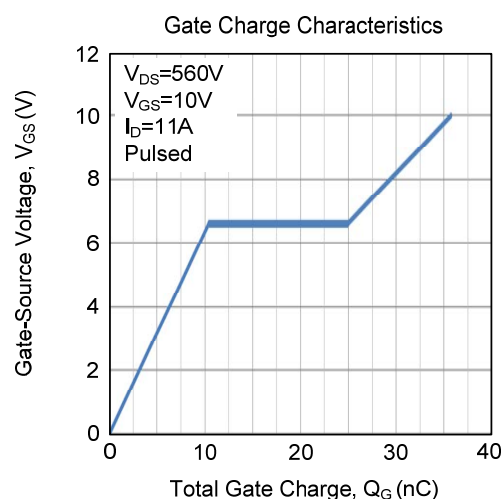
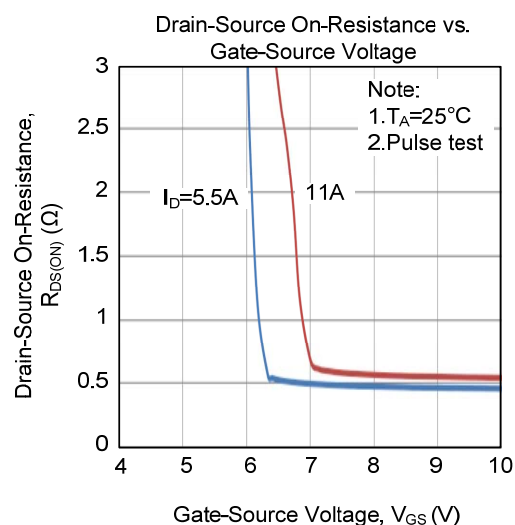
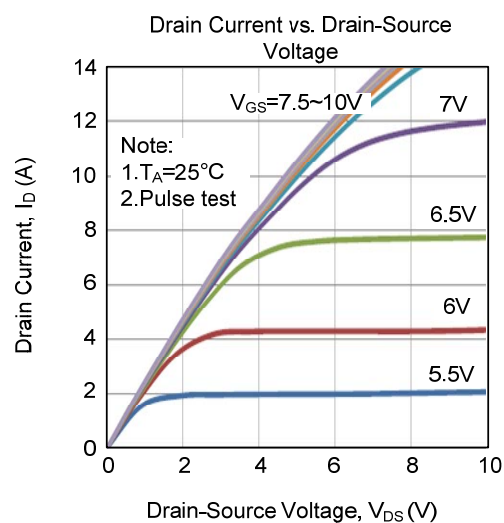


Unclamped Inductive Switching Test Circuit

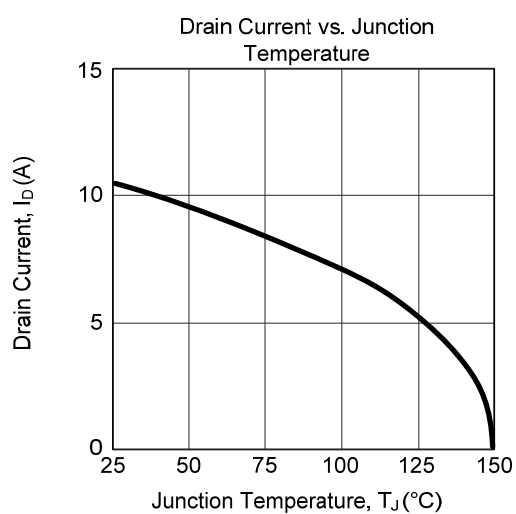
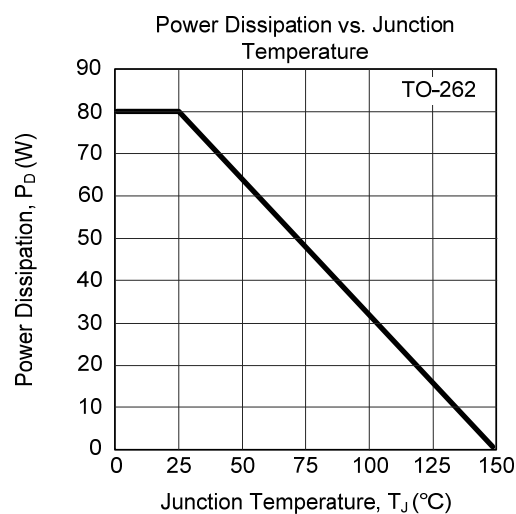
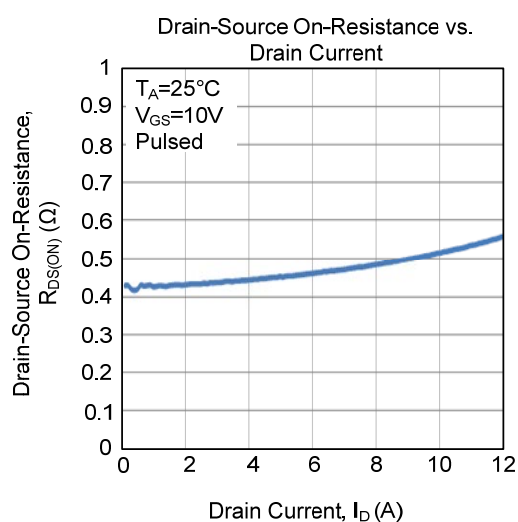
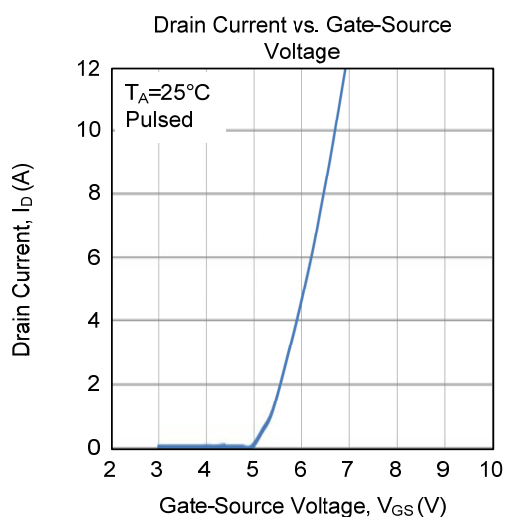
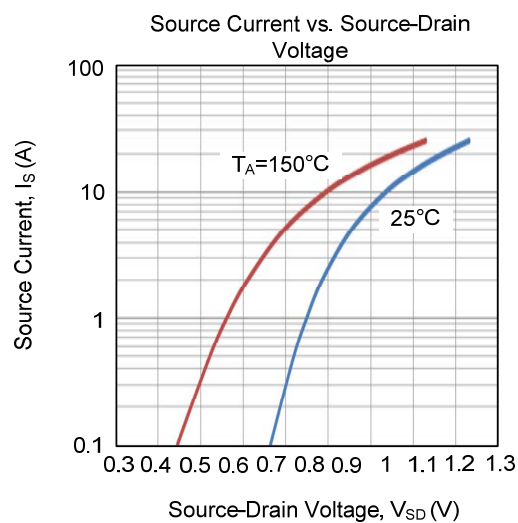
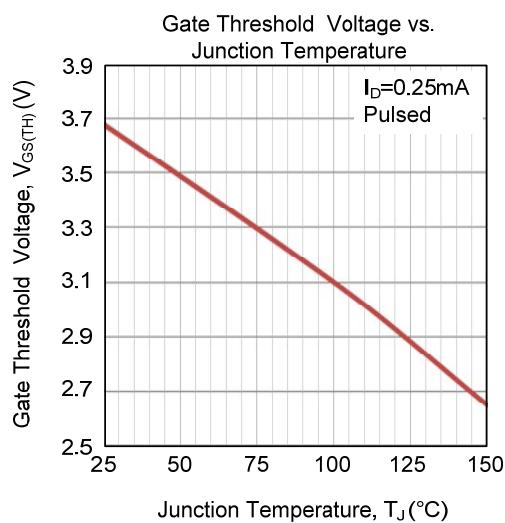


Unclamped Inductive Switching Waveforms

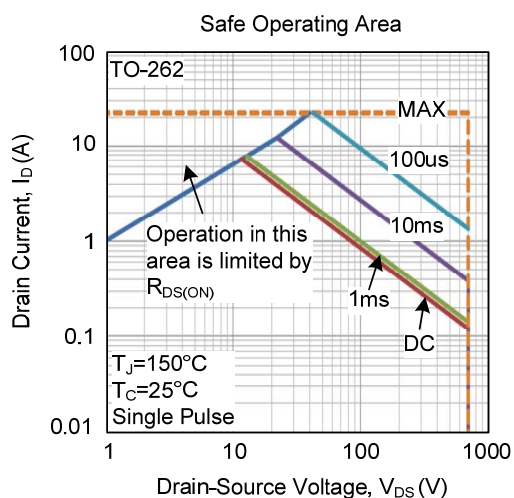
TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



TYPICAL CHARACTERISTICS (Cont.)



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